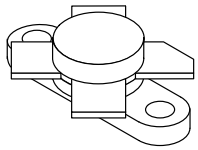
The RF Line
NPN Silicon RF Power Transistor

. . . designed for high gain driver and output linear amplifier stages in 1.5 to 30 MHz HF/SSB equipment.

- Specified 28 Volt, 30 MHz Characteristics —
  Output Power = 25 W (PEP)
  Minimum Gain = 22 dB
  Efficiency = 35%
- Intermodulation Distortion @ 25 W (PEP) —
  IMD = –30 dB (Max)
- 100% Tested for Load Mismatch at all Phase Angles with 30:1 VSWR
- Class A and AB Characterization
- BLX 13 Equivalent

MRF426

**25 W (PEP), 30 MHz
RF POWER
TRANSISTOR
NPN SILICON**



CASE 211–07, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	35	Vdc
Collector–Base Voltage	V_{CBO}	65	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	3.0	Adc
Withstand Current — 5 s	—	6.0	Adc
Total Device Dissipation @ T_C = 25°C (1) Derate above 25°C	P_D	70 0.4	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.5	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, I_B = 0)	$V_{(BR)CEO}$	35	—	—	Vdc
Collector–Base Breakdown Voltage (I_C = 50 mAdc, I_E = 0)	$V_{(BR)CBO}$	65	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 10 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CE} = 28 Vdc, V_{BE} = 0)	I_{CES}	—	—	10	mAdc

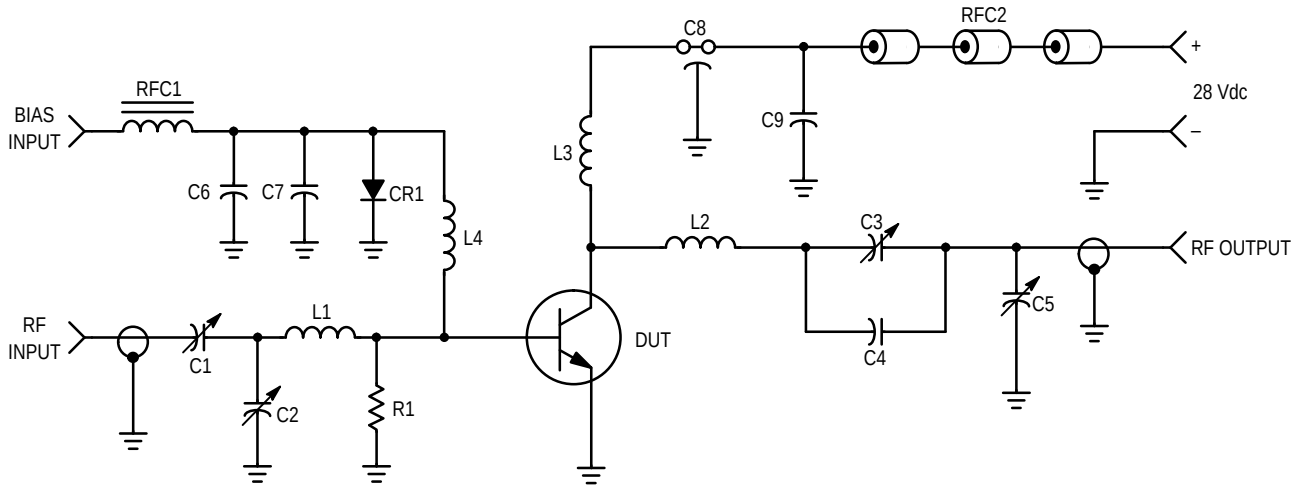
NOTE: (continued)

1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (I_C = 1.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	10	35	—	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 30 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	60	80	pF
FUNCTIONAL TESTS (SSB)					
Common–Emitter Amplifier Gain (V_{CC} = 28 Vdc, P_{out} = 25 W (PEP), f1 = 30 MHz, f2 = 30.001 MHz, I_{CQ} = 25 mA)	G_{PE}	22	25	—	dB
Collector Efficiency (V_{CC} = 28 Vdc, P_{out} = 25 W (PEP), f1 = 30 MHz, f2 = 30.001 MHz, I_{CQ} = 25 mA)	η	35	—	—	%
Intermodulation Distortion (2) (V_{CC} = 28 Vdc, P_{out} = 25 W (PEP), f1 = 30 MHz, f2 = 30.001 MHz, I_{CQ} = 25 mA)	$IMD_{(d3)}$	—	–35	–30	dB
Load Mismatch (V_{CC} = 28 Vdc, P_{out} = 25 W (PEP), f1 = 30 MHz, f2 = 30.001 MHz, I_{CQ} = 25 mA, VSWR 30:1 at All Phase Angles)	ψ	No Degradation in Output Power			
CLASS A PERFORMANCE					
Intermodulation Distortion (2) and Power Gain (V_{CC} = 28 Vdc, P_{out} = 8.0 W (PEP), f1 = 30 MHz, f2 = 30.001 MHz, I_{CQ} = 1.2 Adc)	G_{PE} $IMD_{(d3)}$ $IMD_{(d5)}$	— — —	23.5 –40 –55	— — —	dB

NOTE:
2. To Mil–Std–1311 Version A, Test Method 2204B, Two Tone, Reference each Tone.



C1, C2 — ARCO 469, 190–780 pF
C3, C4 — ARCO 464, 25–280 pF
C5 — 120 pF Dipped Mica
C6, C7 — 100 μF, 15 Vdc
C8 — 680 pF F.T. Allen Bradley
C9 — 1.0 μF 35 V Tantalum
CR1 — 1N4997

L1 — 3 Turns #16 0.25″ ID
L2 — 6 Turns #16 0.5″ ID
L3 — 7 Turns #20 0.38″ ID
L4 — 10 μH Molded Choke Delevan
RFC1 — Ferroxcube VK200/20–4B
RFC2 — 3–Ferroxcube 5653065–3B
RF — Input/Output Connectors UG53 A/μ
R1 — 10 Ω 1/2 Watt 10%

Adjust Bias (Base) for I_{CQ} = 20 mA with No RF Applied

Figure 1. 30 MHz Linear Test Circuit

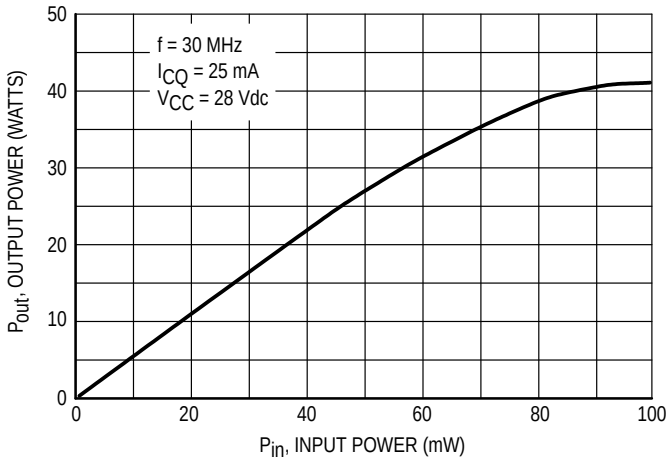


Figure 2. Output Power versus Input Power

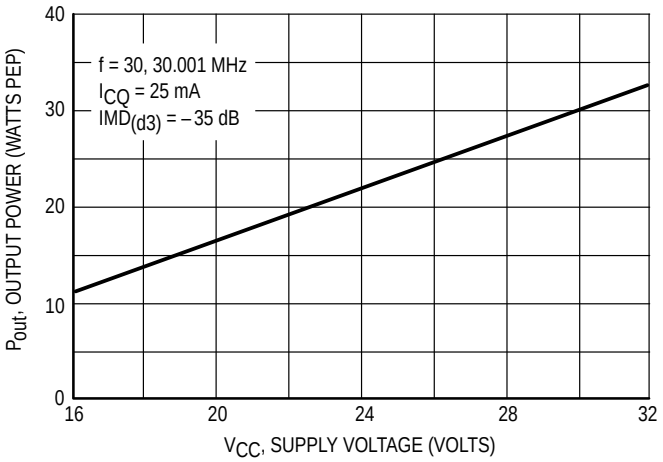


Figure 3. Output Power versus Supply Voltage

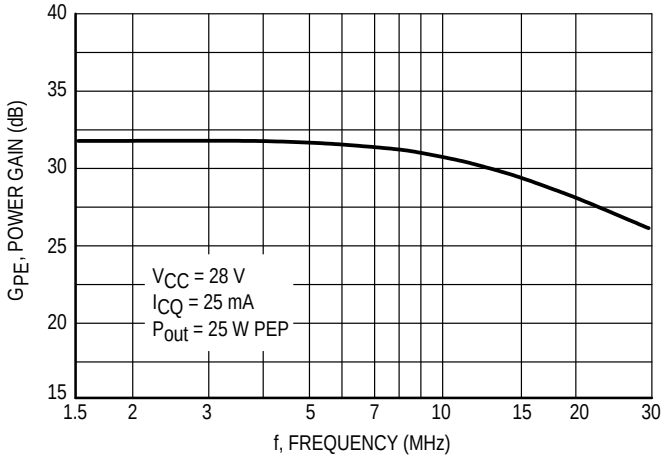


Figure 4. Power Gain versus Frequency

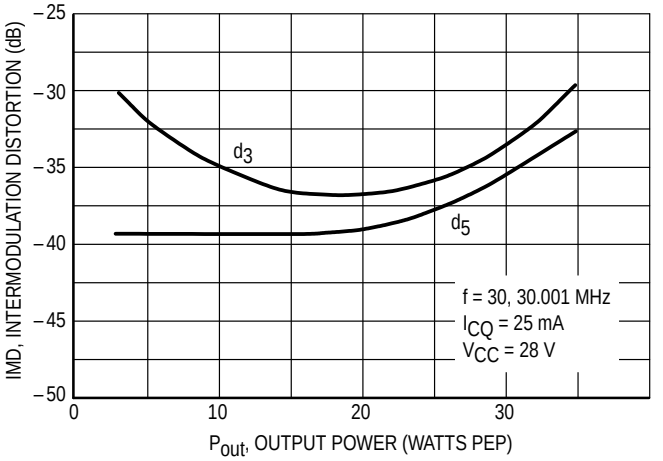


Figure 5. Intermodulation Distortion versus Output Power

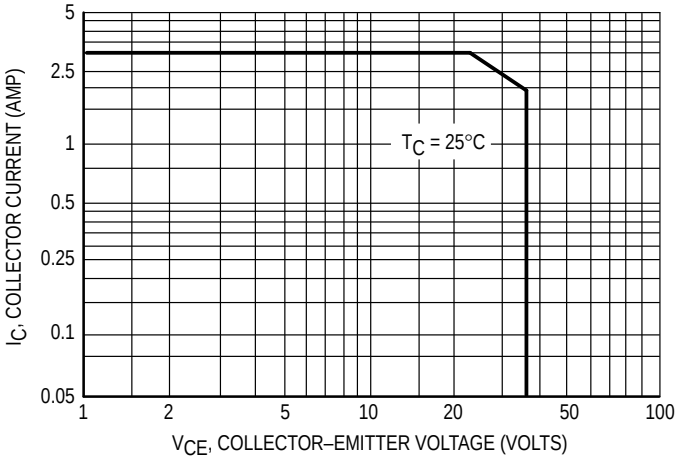


Figure 6. DC Safe Operating Area

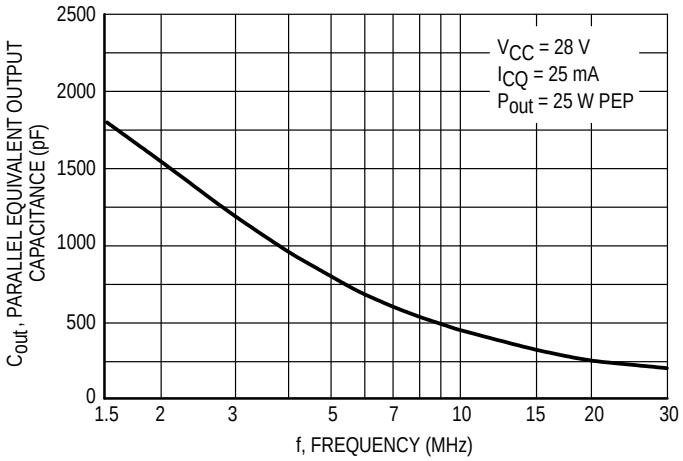


Figure 7. Output Capacitance versus Frequency

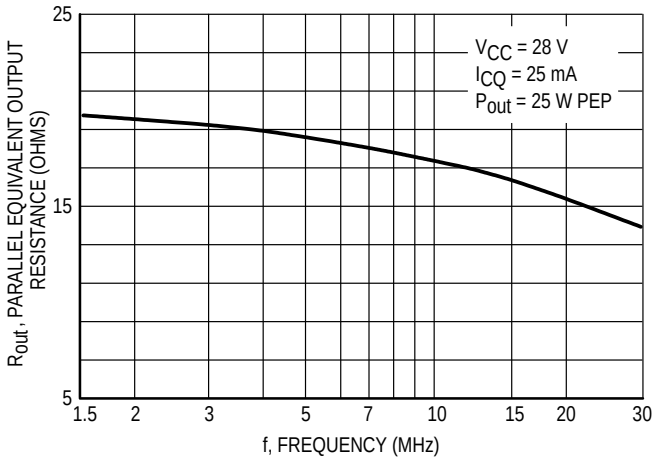


Figure 8. Output Resistance versus Frequency

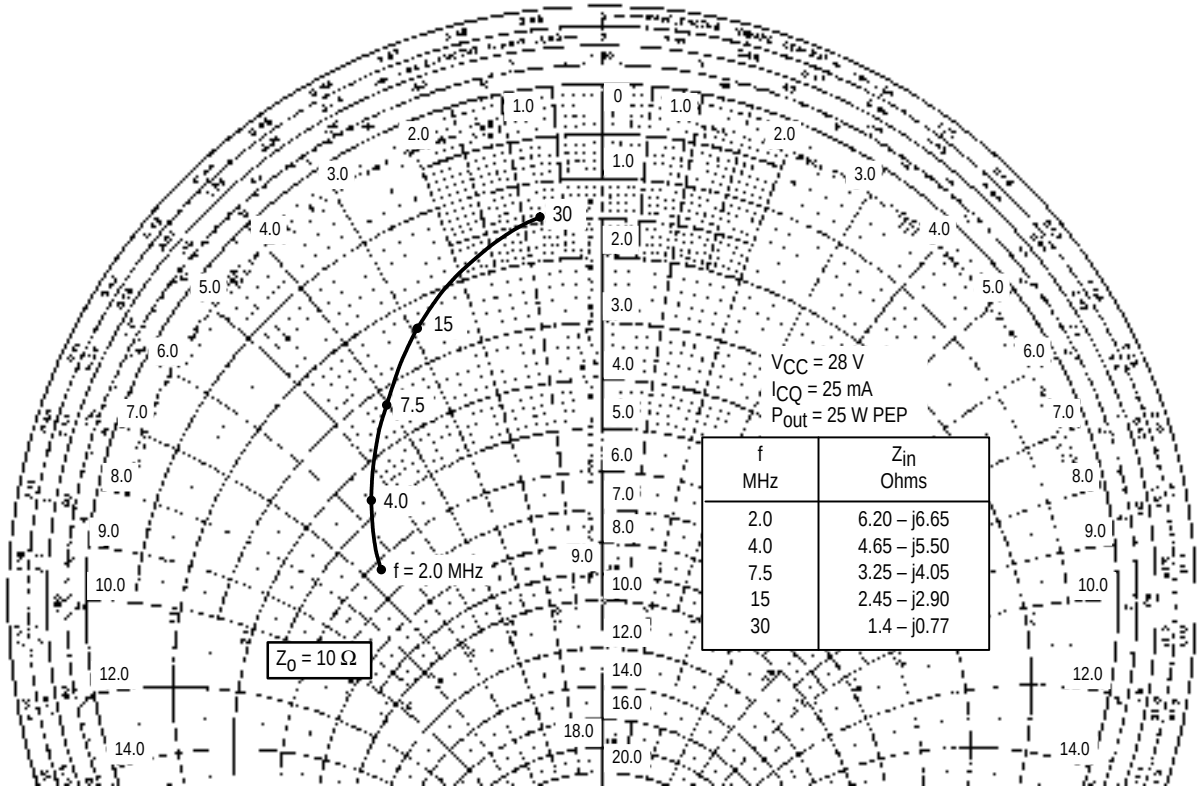
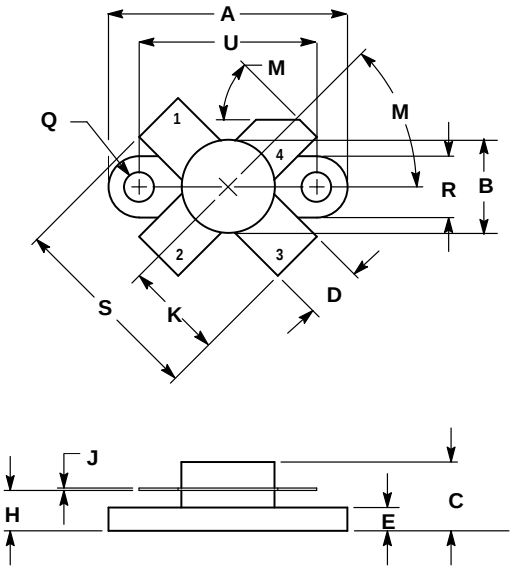


Figure 9. Series Equivalent Input Impedance

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.960	0.990	24.39	25.14
B	0.370	0.390	9.40	9.90
C	0.229	0.281	5.82	7.13
D	0.215	0.235	5.47	5.96
E	0.085	0.105	2.16	2.66
H	0.150	0.108	3.81	4.57
J	0.004	0.006	0.11	0.15
K	0.395	0.405	10.04	10.28
M	40°	50°	40°	50°
Q	0.113	0.130	2.88	3.30
R	0.245	0.255	6.23	6.47
S	0.790	0.810	20.07	20.57
U	0.720	0.730	18.29	18.54

STYLE 1:
PIN 1. EMITTER
2. BASE
3. EMITTER
4. COLLECTOR

CASE 211–07
ISSUE N

Literature Distribution Centers:
USA: Motorola Literature Distribution; P.O. Box 20912; Phoenix, Arizona 85036.
EUROPE: Motorola Ltd.; European Literature Centre; 88 Tanners Drive, Blakelands, Milton Keynes, MK14 5BP, England.
JAPAN: Nippon Motorola Ltd.; 4-32-1, Nishi-Gotanda, Shinagawa-ku, Tokyo 141, Japan.
ASIA PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Center, No. 2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong.